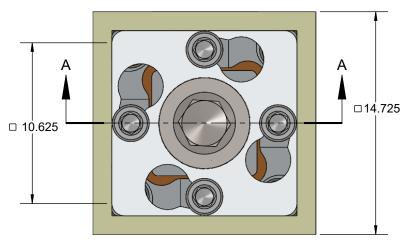
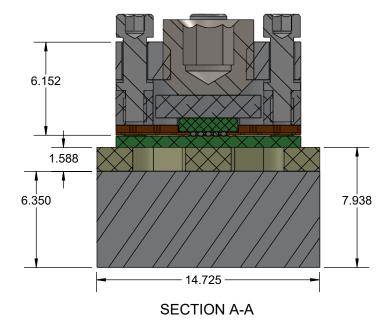
# GHz BGA Socket - Direct mount, solderless



#### **TOP VIEW**



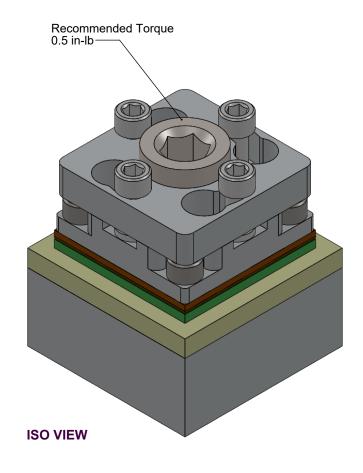
## Description: GT-QFN 3.9x3.9mm 0.5mm pitch QFN24

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

### **Features**

- Directly mounts to target PCB (needs tooling holes) with hardware
  High speed, reliable Elastomer connection
- Minimum real estate required
- Compression plate distributes forces evenly
  Easily removable swivel socket lid



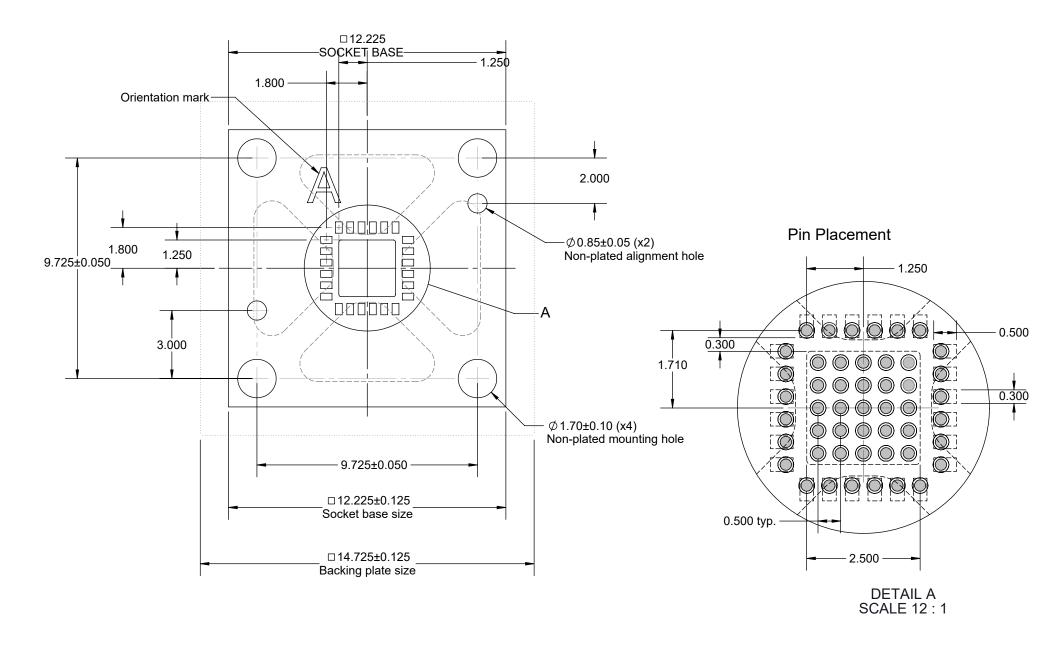
GT-QFN-3007	Drawing
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Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodélectronics.com

Material: N/A Finish: N/A Weight: 7.74

STATUS: Released	SHEET: 1 OF 4	REV. A
ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 4:1
FILE: GT-QFN-3007 Dwg	DATE: 12/09/2015	

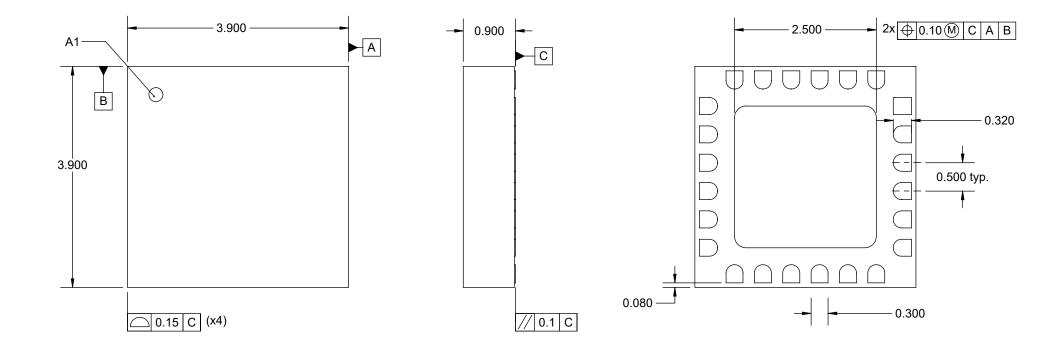


## Description: Recommended PCB Layout

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

#### 



#### Dimensions are in millimeters.

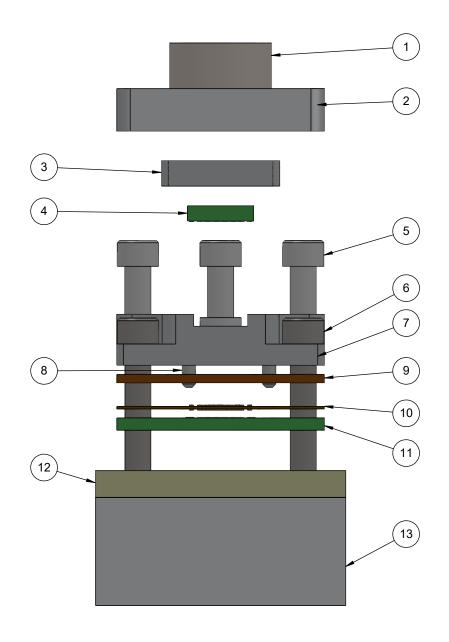
- Interpret dimensions and tolerances per ASME Y14.5M-1994. Parallelism measurement shall exclude any effect of mark on top surface of package. 2.

## **Description: Compatible Device**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

GT-QFN-3007 Drawing	Material: N/A	STATUS: Released	SHEET: 3 OF 4	REV. A
Tele: (800) 404-0204 vveight: 7.74	ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 15:1	
	FILE: GT-QFN-3007 Dwg	DATE: 12/09/2015		

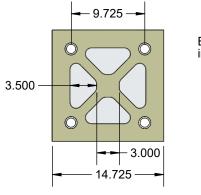


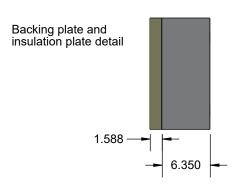
## Description: Socket, Backing Plate Detail

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

ITEM NO.	DESCRIPTION	Material
1	Compression Screw M6x1	Stainless Steel (18-8)
2	Socket Lid 7mm	7075-T6 Aluminum Alloy
3	Compression Plate 7mm IC, 1.5mm thick	7075-T6 (SN)
4	Test Chip 3.9x3.9mm 0.5mm pitch QFN24	FR4 High temp
5	#0-80 Shoulder Screw, 1.59mm thread length	Stainless Steel (303)
6	#0-80 X .375 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE	Alloy Steel
7	Socket Base 7mm	7075-T6 (SN)
8	Alignment Pin 1/32" dia. x 1/8" Ing	Chrome Stainless Steel
9	IC guide 3.9x3.9mm QFN24	Kapton Polyimide/Cirlex
10	GT elastomer for 3.9x3.9mm 0.5mm pitch QFN24	N/A
11	Test PCB 3.9x3.9mm 0.5mm pitch QFN24	FR4 High temp
12	Insulation Plate 7mm	FR4 Standard
13	Backing Plate	7075-T6 Aluminum Alloy





GT-QFN-3007	' Drawing
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Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 7.74

STATUS: Released	SHEET: 4 OF 4	REV. A
ENG: S. Huang	DRAWN BY: M. Raske	SCALE: 4.5:1
FILE: GT-QFN-3007 Dwg	DATE: 12/09/2015	